Special Issue

Complex Interactions with Drops

Message from the Guest Editor

Technology development trends illustrate that the most significant breakthrough technologies in the fields microelectronics, energy, medicine, petrochemical and aerospace engineering are based on processes where energy carriers are used in the form of drops, for example, spreading, evaporation, boiling, condensation, mixing, heat and mass transfer. In this Special Issue, we aim to present cutting-edge research and the latest achievements related to processes with drops. We welcome experimental and theoretical studies, as well as review papers.

Guest Editor

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Deadline for manuscript submissions

closed (20 December 2023)



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Fluids (ISSN 2311-5521) is an international journal on all aspects of fluids in open access format: research articles, reviews and other contents are released on the internet immediately after acceptance. You are invited to contribute a research article or a comprehensive review for consideration and publication in Fluids. The scientific community and the general public have unlimited free access to the content as soon as it is published. Please consider Fluids as an exceptional, exciting enterprise ready to reward your trust, attention, and active participation.

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